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## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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### Complete if Known

Application Number	10/571,044
Filing Date	March 3, 2006
First Named Inventor	Takashi Oku
Group Art Unit	2875
Examiner Name	Mary Zettl
Attorney Docket Number	075834.00553

Sheet 1 of 1

### U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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	US1					
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### FOREIGN PATENT DOCUMENTS

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		Office <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> (if known)				
	F1	JP	2001-112777		Olympus Optical Co Ltd	04/24/2001		
	F2	JP	11-038207		Dainippon Printing Co Ltd	02/12/1999		
	F3	JP	08-335044		Dainippon Printing Co Ltd	12/17/1996		
	F4	JP	08-254604		Omron Corp	10/01/1996		
	F5	JP	08-184704		Sekisui Chem Co Ltd	07/16/1996		
	F6	JP	08-062428		Dainippon Printing Co Ltd	03/08/1996		
	F7	JP	06-301021		Hitachi Ltd	10/28/1994		
	F8	JP	06-201904		Dainippon Printing Co Ltd	07/22/1994		
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S04P1318US00	10/571044	OA (JP)

## CORRESPONDING JAPANESE PATENT APPLICATION

JP	2003	-	338308	OA issued on: 2008/2/7	[HQ-CASE]
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2	JPA		2003 - 240921	cited ( JPA 2003 240921 )		
3	JPA		2000 - 030515	cited ( JPA 2000 030515 )		
4	JPA	HEI	09 - 101405	cited ( JPA 1997 101405 )		
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